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STF12N65M2

N-channel 650 V, 0.42 Ω typ., 8 A MDmesh[™] M2 Power MOSFET in a TO-220FP package

Datasheet - production data

TO-220FP

Figure 1: Internal schematic diagram



Features

Order code	VDS	RDS(on) max.	ID
STF12N65M2	650 V	0.50 Ω	8 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh[™] M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STF12N65M2	12N65M2	TO-220FP	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
D ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	8	А
ID(*)	Drain current (continuous) at T _{case} = 100 °C	5	A
IDM ⁽²⁾	Drain current (pulsed)	32	А
P _{TOT}	Total dissipation at T _{case} = 25 °C	25	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	V/IIS
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_c = 25$ °C)	2.5	kV
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	-55 to 150	C

Notes:

⁽¹⁾ Limited by package.

 $^{\left(2\right) }$ Pulse width is limited by safe operating area.

 $^{(3)}$ Isp ≤ 8 A, di/dt = 400 A/µs; V_DS(peak) < V(BR)DSS, V_DD = 400 V

 $^{(4)}$ V_{DS} \leq 520 V

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	5	°C 11/	
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W	

Table 4: Avalanche characteristics

Symbol Parameter		Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	1.6	А
Eas ⁽¹⁾	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$; $V_{DD} = 50$ V)	250	mJ

Notes:

 $^{(1)}$ Starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	650			V
	Zoro goto voltago droin	$V_{GS} = 0 V, V_{DS} = 650 V$			1	
IDSS Zero-gate voltage drain current	0 0				100	μA
Igss	Gate-body leakage current	$V_{DS} = 0 V$, $V_{GS} = \pm 25 V$			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4 \text{ A}$		0.42	0.50	Ω

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	535	-	
Coss	Output capacitance	$V_{DS} = 100 V$, f = 1 MHz,	-	25	-	рF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V	-	1.1	-	Ρ.
C _{oss} eq. ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 520 V, $V_{GS} = 0$ V	-	144	-	pF
Rg	Intrinsic gate resistance	$f = 1 MHz$, $I_D = 0 A$	-	7	-	Ω
Qg	Total gate charge	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 8 \text{ A}, \text{ V}_{GS} = 0$	-	16.7	-	
Qgs	Gate-source charge	to10 V (see Figure 15: "Test circuit for gate charge	-	2.6	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	8.6	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 325 V, I _D = 4 A	-	9	-	
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	7	-	
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	34	-	ns
t _f	Fall time	and Figure 19: "Switching time waveform")	-	13.5	-	

Table 7: Switching times





Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		-		8	А
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		-		32	А
Vsd ⁽³⁾	Forward on voltage	$V_{GS} = 0 V$, $I_{SD} = 8 A$	-		1.6	V
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	313		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load	-	2.7		μC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	17		A
trr	Reverse recovery time	I _{SD} = 8 A, di/dt = 100 A/µs,	-	462		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	4.1		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	17.5		A

Notes:

⁽¹⁾Limited by package.

⁽²⁾ Pulse width is limited by safe operating area.

 $^{(3)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.



2.1 Electrical characteristics (curves)







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Electrical characteristics







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3 Test circuits









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.









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Package information

Table 9: TO-220FP package mechanical data					
Dim	mm				
Dim.	Min.	Тур.	Max.		
А	4.4		4.6		
В	2.5		2.7		
D	2.5		2.75		
E	0.45		0.7		
F	0.75		1		
F1	1.15		1.70		
F2	1.15		1.70		
G	4.95		5.2		
G1	2.4		2.7		
Н	10		10.4		
L2		16			
L3	28.6		30.6		
L4	9.8		10.6		
L5	2.9		3.6		
L6	15.9		16.4		
L7	9		9.3		
Dia	3		3.2		



Revision history 5

Date	Revision	Changes
16-Dec-2014	1	First release.
11-Mar-2015	2	Updated features in cover page. Minor text changes
06-Jun-2017	3	Updated Section 1: "Electrical ratings", Section 2: "Electrical characteristics" and Section 2.1: "Electrical characteristics (curves)".



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